

December 2013

74VCX08 Low Voltage Quad 2-Input AND Gate with 3.6V Tolerant Inputs and Outputs

Features

- 1.2V to 3.6V V_{CC} supply operation
- 3.6V tolerant inputs and outputs
- t_{PD}:
- 2.8ns max. for 3.0V to 3.6V V_{CC}
- Power-off high impedance inputs and outputs
- Static Drive (I_{OH}/I_{OL})
 - ±24mA @ 3.0V V_{CC}
- Uses proprietary Quiet Series[™] noise/EMI reduction circuitry
- Latchup performance exceeds 300mA
- ESD performance:
 - Human body model > 2000V
- Machine model > 250V
- Leadless DQFN package

General Description

The VCX08 contains four 2-input AND gates. This product is designed for low voltage (1.2V to 3.6V) V_{CC} applications with I/O compatibility up to 3.6V.

The VCX08 is fabricated with an advanced CMOS technology to achieve high-speed operation while maintaining low CMOS power dissipation.

Ordering Information

Order Number	Package Number	Package Description
74VCX08M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
74VCX08BQX ⁽¹⁾	MLP14A	14-Terminal Depopulated Quad Very-Thin Flat Pack No Leads (DQFN), JEDEC MO-241, 2.5 x 3.0mm
74VCX08MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

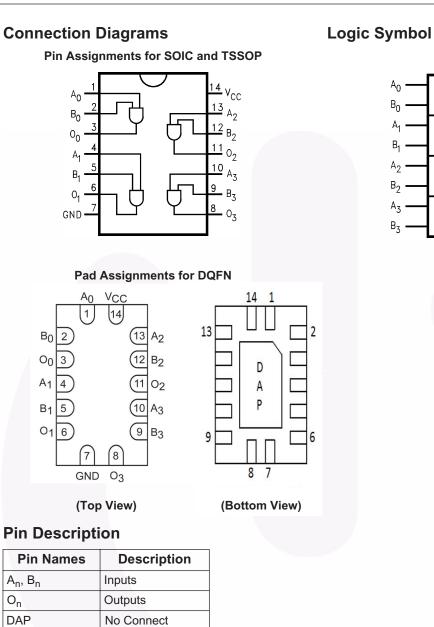
Note:

1. DQFN package available in Tape and Reel only.

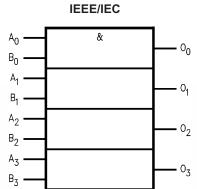
Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.

All packages are lead free per JEDEC: J-STD-020B standard.

74VCX08 — Low Voltage Quad 2-Input AND Gate with 3.6V Tolerant Inputs and Outputs



Note: DAP (Die Attach Pad)



Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V _{CC}	Supply Voltage	-0.5V to +4.6V
VI	DC Input Voltage	-0.5V to 4.6V
V _O	DC Output Voltage HIGH or LOW State ⁽²⁾	–0.5V to V _{CC} +0.5V
	$V_{CC} = 0V$	-0.5V to +4.6V
I _{IK}	DC Input Diode Current, V _I < 0V –5	
I _{ОК}	DC Output Diode Current	
	$V_{O} < 0V$	–50mA
	V _O > V _{CC}	+50mA
I _{OH} / I _{OL}	DC Output Source/Sink Current	
$I_{\rm CC}$ or GND	DC V _{CC} or Gound Current per Supply Pin ±100	
T _{STG}	Storage Temperature Range -65°C to +150	

Note:

2. I_O Absolute Maximum Rating must be observed.

Recommended Operating Conditions⁽³⁾

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Rating
V _{CC}	Power Supply Operating	1.2V to 3.6V
VI	Input Voltage	-0.3V to 3.6V
V _O	Output Voltage, HIGH or LOW State	0V to V _{CC}
I _{OH} / I _{OL}	Output Current	
	$V_{CC} = 3.0V$ to 3.6V	±24mA
	V _{CC} = 2.3V to 2.7V	±18mA
	$V_{CC} = 1.65V \text{ to } 2.3V$	±6mA
	V _{CC} = 1.4V to 1.6V	±2mA
	$V_{CC} = 1.2V$	±100µA
T _A	Free Air Operating Temperature	-40°C to +85°C
$\Delta t / \Delta V$	Minimum Input Edge Rate, $V_{IN} = 0.8V$ to 2.0V, $V_{CC} = 3.0V$	10ns/V

Note:

3. Floating or unused inputs must be held HIGH or LOW

Symbol	Parameter	$V_{CC}(V)$	Conditions	Min	Max	Units
V _{IH}	HIGH Level Input Voltage	2.7–3.6		2.0		V
		2.3–2.7		1.6		
		1.65–2.3		$0.65 \times V_{CC}$		
		1.4–1.6		$0.65 \times V_{CC}$		
		1.2		$0.65 \times V_{CC}$		
V _{IL}	LOW Level Input Voltage	2.7–3.6			0.8	V
		2.3–2.7			0.7	
		1.65–2.3			$0.35 \times V_{CC}$	
		1.4–1.6			$0.35 \times V_{CC}$	
		1.2			0.05 x V _{CC}	
V _{OH}	HIGH Level Output Voltage	2.7–3.6	I _{OH} = -100µA	$V_{CC} - 0.2$		V
		2.7	$I_{OH} = -12mA$	2.2		
		3.0	$I_{OH} = -18 \text{mA}$	2.4		
		3.0	$I_{OH} = -24mA$	2.2		
		2.3–2.7	I _{OH} = -100µA	V _{CC} - 0.2		
		2.3	$I_{OH} = -6mA$	2.0		1
		2.3	$I_{OH} = -12mA$	1.8		-
		2.3	$I_{OH} = -18 \text{mA}$	1.7		
		1.65–2.3	$I_{OH} = -100 \mu A$	V _{CC} – 0.2		
		1.65	$I_{OH} = -6mA$	1.25		
		1.4–1.6	I _{OH} = -100µA	V _{CC} - 0.2		
		1.4	$I_{OH} = -2mA$	1.05		
		1.2	I _{OH} = -100µA	V _{CC} - 0.2		
V _{OL}	LOW Level Output Voltage	2.7–3.6	$I_{OL} = 100 \mu A$		0.2	V
		2.7	$I_{OL} = 12mA$		0.4	
		3.0	I _{OL} = 18mA		0.4	
		3.0	$I_{OL} = 24 \text{mA}$		0.55	
		2.3–2.7	I _{OL} = 100μA		0.2	
		2.3	$I_{OL} = 12mA$		0.4	
		2.3	I _{OL} = 18mA		0.6	
		1.65–2.3	$I_{OL} = 100 \mu A$		0.2	
		1.65	$I_{OL} = 6mA$		0.2	
		1.4–1.6	I _{OL} = 100µA		0.2	
		1.4	$I_{OL} = 2mA$		0.35	
		1.2	I _{OL} = 100μA		0.05	
l _l	Input Leakage Current	1.2–3.6	$0 \le V_I \le 3.6V$		±5.0	μA
I _{OFF}	Power-OFF Leakage Current	0	$0 \leq (V_I, V_O) \leq 3.6V$		10	μA
I _{CC}	Quiescent Supply Current	1.2–3.6	$V_I = V_{CC}$ or GND		20	μA
			$V_{CC} \le V_I \le 3.6V$		±20	
ΔI_{CC}	Increase in I _{CC} per Input	2.7–3.6	$V_{IH} = V_{CC} - 0.6V$		750	μA

AC Electrical Characteristics⁽⁴⁾

					T _A = -40°C to +85°C		Figure
Symbol	Parameter	V _{CC} (V)	Conditions	Min.	Max.	Units	Number
t _{PHL} , t _{PLH}	Propagation Delay	3.3 ± 0.3	$C_L = 30 pF, R_L = 500 \Omega$	0.6	2.8	ns	Fig. 1
		2.5 ± 0.2		0.8	3.7	1	Fig. 2
		1.8 ± 0.15		1.0	7.4	1	
		1.5 ± 0.1	$C_L = 15 pF, R_L = 2k\Omega$	1.0	14.8]	Fig. 3
		1.2		1.5	37.0	1	Fig. 4
t _{OSHL} , t _{OSLH}	Output to Output	3.3 ± 0.3	$C_L = 30 pF, R_L = 500 \Omega$		0.5	ns	
	Skew ⁽⁵⁾	2.5 ± 0.2			0.5	1	
		1.8 ± 0.15			0.75		
		1.5 ± 0.1	$C_L = 15 pF, R_L = 2k\Omega$		1.5	1	
		1.2			1.5		

Note:

4. For $C_L = 50 pF$, add approximately 300ps to the AC Maximum specification.

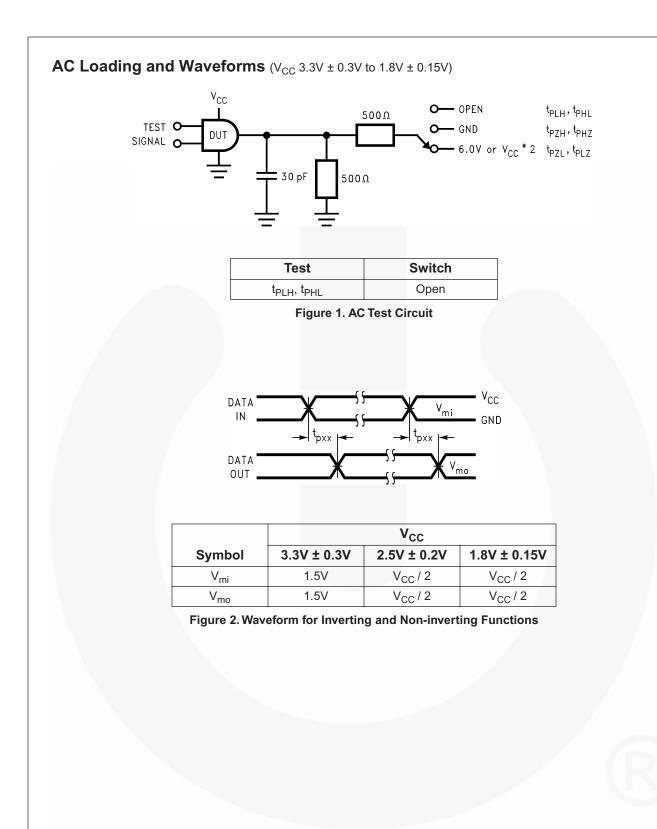
 Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}).

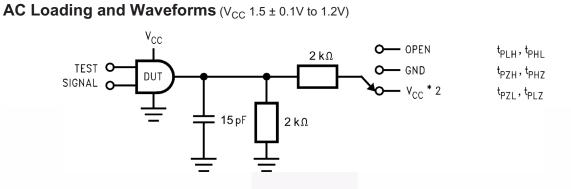
Dynamic Switching Characteristics

				$T_A = 25^{\circ}C$	
Symbol	Parameter	V _{CC} (V)	Conditions	Typical	Unit
V _{OLP}	Quiet Output Dynamic Peak V _{OL}	1.8	$C_L = 30 pF, V_{IH} = V_{CC},$	0.25	V
		2.5	$V_{IL} = 0V$	0.6	
		3.3		0.8	
V _{OLV}	Quiet Output Dynamic Valley V _{OL}	1.8	$C_L = 30 pF, V_{IH} = V_{CC},$	-0.25	V
		2.5	$V_{IL} = 0V$	-0.6	
		3.3		-0.8	
V _{OHV}	Quiet Output Dynamic Valley V _{OH}	1.8	$C_L = 30 pF, V_{IH} = V_{CC},$	1.5	V
		2.5	$V_{IL} = 0V$	1.9	
		3.3		2.2	

Capacitance

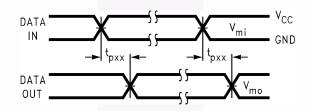
			T _A = +25°C	
Symbol	Parameter	Conditions	Typical	Units
C _{IN}	Input Capacitance	$V_{I} = 0V \text{ or } V_{CC}, V_{CC} = 1.8V, 2.5V \text{ or } 3.3V$	6.0	pF
C _{OUT}	Output Capacitance	$V_{I} = 0V \text{ or } V_{CC}, V_{CC} = 1.8V, 2.5V \text{ or } 3.3V$	7.0	pF
C _{PD}	Power Dissipation Capacitance	$V_{\rm I}$ = 0V or V_{CC},f = 10MHz, V_{CC} = 1.8V, 2.5V or 3.3V	20.0	pF





Test	Switch
t _{PLH} , t _{PHL}	Open
t _{PZL} , t _{PLZ}	V_{CC} x 2 at V_{CC} = 1.5V ± 0.1V
t _{PZH} , t _{PHZ}	GND

Figure 3. AC Test Circuit



	V _{cc}
Symbol	1.5V ± 0.1V
V _{mi}	V _{CC} / 2
V _{mo}	V _{CC} / 2

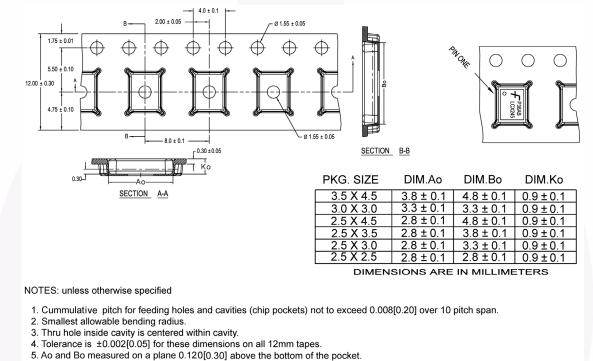
Figure 4. Waveform for Inverting and Non-Inverting Functions

Tape and Reel Specification

Tape Format for DQFN

Package Designator	Tape Section	Number of Cavities	Cavity Status	Cover Tape Status
BQX	Leader (Start End)	125 (Typ.)	Empty	Sealed
	Carrier		Filled	Sealed
	Trailer (Hub End)	75 (Тур.)	Empty	Sealed

Tape Dimensions inches (millimeters)



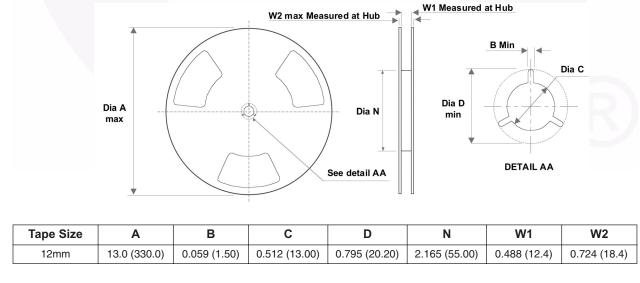
Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier.

- 7. Pocket position relative to sprocket hole measured as true position of pocket. Not pocket hole.
- 8. Controlling dimension is millimeter. Diemension in inches rounded.

Reel Dimensions inches (millimeters)

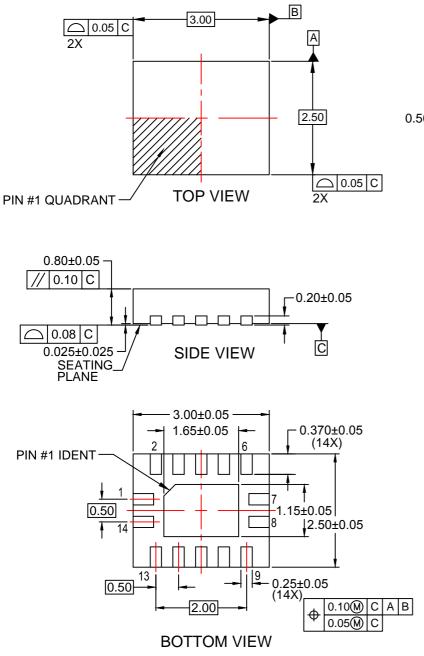
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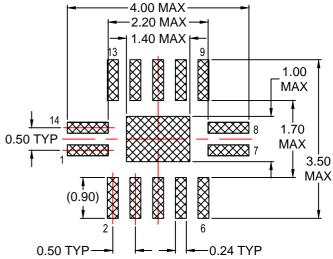
74VCX08 Rev. 1.9.1











RECOMMENDED LAND PATTERN

NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-241, VARIATION AA
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.
- E. DRAWING FILENAME: MKT-MLP14Arev2.



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